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Details

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Product Status	Obsolete
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	83
Program Memory Size	192KB (65.5K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj192gb110t-i-pt

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		Pin Number				
Function	64-Pin TQFP, QFN	80-Pin TQFP	100-Pin TQFP	I/O	Input Buffer	Description
D+	37	47	57	I/O	—	USB Differential Plus line (internal transceiver).
D-	36	46	56	I/O	_	USB Differential Minus line (internal transceiver).
DMH	46	58	72	0	_	D- External Pull-up Control Output.
DMLN	42	54	68	0	_	D- External Pull-down Control Output.
DPH	50	62	77	0	_	D+ External Pull-up Control Output.
DPLN	43	55	69	0	_	D+ External Pull-down Control Output.
ENVREG	57	71	86	I	ST	Voltage Regulator Enable.
INT0	46	58	72	I	ST	External Interrupt Input.
MCLR	7	9	13	I	ST	Master Clear (device Reset) Input. This line is brought low to cause a Reset.
OSCI	39	49	63	I	ANA	Main Oscillator Input Connection.
OSCO	40	50	64	0	ANA	Main Oscillator Output Connection.
PGEC1	15	19	24	I/O	ST	In-Circuit Debugger/Emulator/ICSP™ Programming Clock.
PGED1	16	20	25	I/O	ST	In-Circuit Debugger/Emulator/ICSP Programming Data.
PGEC2	17	21	26	I/O	ST	In-Circuit Debugger/Emulator/ICSP Programming Clock.
PGED2	18	22	27	I/O	ST	In-Circuit Debugger/Emulator/ICSP Programming Data.
PGEC3	11	15	20	I/O	ST	In-Circuit Debugger/Emulator/ICSP Programming Clock.
PGED3	12	16	21	I/O	ST	In-Circuit Debugger/Emulator/ICSP Programming Data.
PMA0	30	36	44	I/O	ST	Parallel Master Port Address Bit 0 Input (Buffered Slave modes) and Output (Master modes).
PMA1	29	35	43	I/O	ST	Parallel Master Port Address Bit 1 Input (Buffered Slave modes) and Output (Master modes).
PMA2	8	10	14	0	—	Parallel Master Port Address (Demultiplexed Master
PMA3	6	8	12	0	—	modes).
PMA4	5	7	11	0	—	
PMA5	4	6	10	0	—	
PMA6	16	24	29	0	—	
PMA7	22	23	28	0	—	
PMA8	32	40	50	0	—	
PMA9	31	39	49	0	—	
PMA10	28	34	42	0	—	
PMA11	27	33	41	0	—	
PMA12	24	30	35	0	—	
PMA13	23	29	34	0	- 1	
PMCS1	45	57	71	I/O	ST/TTL	Parallel Master Port Chip Select 1 Strobe/Address Bit 15.
PMCS2	44	56	70	0	ST	Parallel Master Port Chip Select 2 Strobe/Address Bit 14.
PMBE	51	63	78	0	—	Parallel Master Port Byte Enable Strobe.
Leaend:	TTL = TTL in	and handfam				Schmitt Trigger input buffer

TABLE 1-4: PIC24FJ256GB110 FAMILY PINOUT DESCRIPTIONS (CONTINUED)

Legend: TTL = TTL input buffer ANA = Analog level input/output ST = Schmitt Trigger input buffer $I^2C^{TM} = I^2C/SMBus$ input buffer

2.7 Configuration of Analog and Digital Pins During ICSP Operations

If an ICSP compliant emulator is selected as a debugger, it automatically initializes all of the A/D input pins (ANx) as "digital" pins. Depending on the particular device, this is done by setting all bits in the ADnPCFG register(s), or clearing all bit in the ANSx registers.

All PIC24F devices will have either one or more ADnPCFG registers or several ANSx registers (one for each port); no device will have both. Refer to **Section 22.0 "10-Bit High-Speed A/D Converter"** for more specific information.

The bits in these registers that correspond to the A/D pins that initialized the emulator must not be changed by the user application firmware; otherwise, communication errors will result between the debugger and the device.

If your application needs to use certain A/D pins as analog input pins during the debug session, the user application must modify the appropriate bits during initialization of the ADC module, as follows:

- For devices with an ADnPCFG register, clear the bits corresponding to the pin(s) to be configured as analog. Do not change any other bits, particularly those corresponding to the PGECx/PGEDx pair, at any time.
- For devices with ANSx registers, set the bits corresponding to the pin(s) to be configured as analog. Do not change any other bits, particularly those corresponding to the PGECx/PGEDx pair, at any time.

When a Microchip debugger/emulator is used as a programmer, the user application firmware must correctly configure the ADnPCFG or ANSx registers. Automatic initialization of this register is only done during debugger operation. Failure to correctly configure the register(s) will result in all A/D pins being recognized as analog input pins, resulting in the port value being read as a logic '0', which may affect user application functionality.

2.8 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k Ω to 10 k Ω resistor to Vss on unused pins and drive the output to logic low.

4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC^{\circledast} devices and improve data space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word which contains the byte, using the LSb of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel, byte-wide entities with shared (word) address decode but separate write lines. Data byte writes only write to the corresponding side of the array or register which matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the Least Significant Byte. The Most Significant Byte is not modified.

A sign-extend instruction (SE) is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users can clear the MSB of any W register by executing a zero-extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the near data space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the data space is addressable indirectly. Additionally, the whole data space is addressable using MOV instructions, which support Memory Direct Addressing with a 16-bit address field.

4.2.4 SFR SPACE

The first 2 Kbytes of the near data space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'. A diagram of the SFR space, showing where SFRs are actually implemented, is shown in Table 4-2. Each implemented area indicates a 32-byte region where at least one address is implemented as an SFR. A complete listing of implemented SFRs, including their addresses, is shown in Tables 4-3 through 4-30.

			SFR	Space Add	ess				
	xx00	xx20	xx40	xx60	хх	80	xxA0	xxC0	xxE0
000h		Core		ICN				_	
100h	Tim	ners	(Capture		Compare			
200h	l ² C™	UART	SPI/UART	SPI/I ² C	S	PI	UART I/O		
300h	A/D	A/D/CTMU		—	_	_	—	_	_
400h	_	—		_			USB		_
500h	_	—		_	_	_	_		
600h	PMP	RTC/Comp	CRC	—	PPS				
700h	_	—	System	NVM/PMD	-	_	—	_	—

TABLE 4-2:IMPLEMENTED REGIONS OF SFR DATA SPACE

Legend: — = No implemented SFRs in this block

TABLE 4-3: CPU CORE REGISTERS MAP

IABLE	4-J.	CFUC			R2 MAP													
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
WREG0	0000								Working F	Register 0								0000
WREG1	0002								Working F	Register 1								0000
WREG2	0004								Working F	Register 2								0000
WREG3	0006								Working F	Register 3								0000
WREG4	0008		Working Register 4											0000				
WREG5	000A		Working Register 5											0000				
WREG6	000C		Working Register 6											0000				
WREG7	000E		Working Register 7											0000				
WREG8	0010								Working F	Register 8								0000
WREG9	0012								Working F	Register 9								0000
WREG10	0014								Working R	Register 10								0000
WREG11	0016								Working F	Register 11								0000
WREG12	0018								Working R	Register 12								0000
WREG13	001A								Working R	Register 13								0000
WREG14	001C								Working R	Register 14								0000
WREG15	001E								Working R	Register 15								0800
SPLIM	0020							Stack	Pointer Lin	nit Value Re	egister							xxxx
PCL	002E							Progra	m Counter I	Low Word F	Register							0000
PCH	0030				_	—		—	—			Progra	m Counter	Register Hig	gh Byte			0000
TBLPAG	0032				_	—		—	—			Table N	lemory Pag	e Address I	Register			0000
PSVPAG	0034	_	_	_	_	_	_	_	_		P	rogram Spa	ace Visibility	/ Page Add	ress Registe	er		0000
RCOUNT	0036							Rep	eat Loop C	ounter Reg	ister							xxxx
SR	0042	-	_	_	—		_	_	DC	IPL2	IPL1	IPL0	RA	Ν	OV	Z	С	0000
CORCON	0044	_		_	—	—		-	—	—	—		—	IPL3	PSV	-	_	0000
DISICNT	0052	_	-						Disabl	e Interrupts	Counter R	egister						xxxx

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Interrupt Course	Vector		AIVT	Inte	errupt Bit Locat	ions
Interrupt Source	Number	IVT Address	Address	Flag	Enable	Priority
ADC1 Conversion Done	13	00002Eh	00012Eh	IFS0<13>	IEC0<13>	IPC3<6:4>
Comparator Event	18	000038h	000138h	IFS1<2>	IEC1<2>	IPC4<10:8>
CRC Generator	67	00009Ah	00019Ah	IFS4<3>	IEC4<3>	IPC16<14:12>
CTMU Event	77	0000AEh	0001AEh	IFS4<13>	IEC4<13>	IPC19<6:4>
External Interrupt 0	0	000014h	000114h	IFS0<0>	IEC0<0>	IPC0<2:0>
External Interrupt 1	20	00003Ch	00013Ch	IFS1<4>	IEC1<4>	IPC5<2:0>
External Interrupt 2	29	00004Eh	00014Eh	IFS1<13>	IEC1<13>	IPC7<6:4>
External Interrupt 3	53	00007Eh	00017Eh	IFS3<5>	IEC3<5>	IPC13<6:4>
External Interrupt 4	54	000080h	000180h	IFS3<6>	IEC3<6>	IPC13<10:8>
I2C1 Master Event	17	000036h	000136h	IFS1<1>	IEC1<1>	IPC4<6:4>
I2C1 Slave Event	16	000034h	000134h	IFS1<0>	IEC1<0>	IPC4<2:0>
I2C2 Master Event	50	000078h	000178h	IFS3<2>	IEC3<2>	IPC12<10:8>
I2C2 Slave Event	49	000076h	000176h	IFS3<1>	IEC3<1>	IPC12<6:4>
I2C3 Master Event	85	0000BEh	0001BEh	IFS5<5>	IEC5<5>	IPC21<6:4>
I2C3 Slave Event	84	0000BCh	0001BCh	IFS5<4>	IEC5<4>	IPC21<2:0>
Input Capture 1	1	000016h	000116h	IFS0<1>	IEC0<1>	IPC0<6:4>
Input Capture 2	5	00001Eh	00011Eh	IFS0<5>	IEC0<5>	IPC1<6:4>
Input Capture 3	37	00005Eh	00015Eh	IFS2<5>	IEC2<5>	IPC9<6:4>
Input Capture 4	38	000060h	000160h	IFS2<6>	IEC2<6>	IPC9<10:8>
Input Capture 5	39	000062h	000162h	IFS2<7>	IEC2<7>	IPC9<14:12>
Input Capture 6	40	000064h	000164h	IFS2<8>	IEC2<8>	IPC10<2:0>
Input Capture 7	22	000040h	000140h	IFS1<6>	IEC1<6>	IPC5<10:8>
Input Capture 8	23	000042h	000142h	IFS1<7>	IEC1<7>	IPC5<14:12>
Input Capture 9	93	0000CEh	0001CEh	IFS5<13>	IEC5<13>	IPC23<6:4>
Input Change Notification	19	00003Ah	00013Ah	IFS1<3>	IEC1<3>	IPC4<14:12>
LVD Low-Voltage Detect	72	0000A4h	0001A4h	IFS4<8>	IEC4<8>	IPC18<2:0>
Output Compare 1	2	000018h	000118h	IFS0<2>	IEC0<2>	IPC0<10:8>
Output Compare 2	6	000020h	000120h	IFS0<6>	IEC0<6>	IPC1<10:8>
Output Compare 3	25	000046h	000146h	IFS1<9>	IEC1<9>	IPC6<6:4>
Output Compare 4	26	000048h	000148h	IFS1<10>	IEC1<10>	IPC6<10:8>
Output Compare 5	41	000066h	000166h	IFS2<9>	IEC2<9>	IPC10<6:4>
Output Compare 6	42	000068h	000168h	IFS2<10>	IEC2<10>	IPC10<10:8>
Output Compare 7	43	00006Ah	00016Ah	IFS2<11>	IEC2<11>	IPC10<14:12>
Output Compare 8	44	00006Ch	00016Ch	IFS2<12>	IEC2<12>	IPC11<2:0>
Output Compare 9	92	0000CCh	0001CCh	IFS5<12>	IEC5<12>	IPC23<2:0>
Parallel Master Port	45	00006Eh	00016Eh	IFS2<13>	IEC2<13>	IPC11<6:4>
Real-Time Clock/Calendar	62	000090h	000190h	IFS3<14>	IEC3<14>	IPC15<10:8>
SPI1 Error	9	000026h	000126h	IFS0<9>	IEC0<9>	IPC2<6:4>
SPI1 Event	10	000028h	000128h	IFS0<10>	IEC0<10>	IPC2<10:8>
SPI2 Error	32	000054h	000154h	IFS2<0>	IEC2<0>	IPC8<2:0>
SPI2 Event	33	000056h	000156h	IFS2<1>	IEC2<1>	IPC8<6:4>
SPI3 Error	90	0000C8h	0001C8h	IFS5<10>	IEC5<10>	IPC22<10:8>
SPI3 Event	91	0000CAh	0001CAh	IFS5<11>	IEC5<11>	IPC22<14:12>

TABLE 7-2: IMPLEMENTED INTERRUPT VECTORS

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0					
_	IC8IP2	IC8IP1	IC8IP0	_	IC7IP2	IC7IP1	IC7IP0					
oit 15							bit					
						DAVO						
U-0	U-0	U-0	U-0	U-0	R/W-1 INT1IP2	R/W-0 INT1IP1	R/W-0 INT1IP0					
 bit 7		_		_	INT IF2		bit					
Legend:												
R = Readat		W = Writable		•	nented bit, read							
-n = Value a	at POR	'1' = Bit is set	i .	'0' = Bit is clea	ared	x = Bit is unkr	iown					
bit 15	Unimplemen	ted: Read as '	0'									
bit 14-12	-			rupt Priority bits	s							
510 T T T E		pt is priority 7 (
	•		ingricer priority	interrupt)								
	•											
	•											
	001 = Interru											
	-	pt source is dis										
bit 11	-	ted: Read as '										
bit 10-8	IC7IP<2:0>: Input Capture Channel 7 Interrupt Priority bits											
	<pre>111 = Interrupt is priority 7 (highest priority interrupt)</pre>											
	•	•										
	•											
	• 001 = Interrupt is priority 1											
	000 = Interrupt source is disabled											
bit 7-3		ted: Read as '										
bit 2-0	-			oits								
	INT1IP<2:0>: External Interrupt 1 Priority bits 111 = Interrupt is priority 7 (highest priority interrupt)											
	•											
	•											
	•											
	001 = Interru	pt is priority 1 pt source is dis										

REGISTER 7-22: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5

U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—		—	_	—	—		
						bit 8	
D 447 4	D 444 0	D 444 0				D 4 4 4 6	
	1		0-0		1	R/W-0	
PMPIP2	PMPIP1	PMPIP0	—	OC8IP2	OC8IP1	OC8IP0	
						bit C	
e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'		
POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown		
<pre>111 = Interrup</pre>	pt is priority 7 (pt is priority 1 pt source is dis ted: Read as ' Output Compa	nighest priority abled o' ire Channel 8 I	interrupt) nterrupt Priority	/ bits			
	R/W-1 PMPIP2 e bit POR Unimplemen PMPIP<2:0>: 111 = Interrup •	R/W-1 R/W-0 PMPIP2 PMPIP1 e bit W = Writable POR '1' = Bit is set Unimplemented: Read as '0 PMPIP<2:0>: Parallel Maste 111 = Interrupt is priority 7 (I •<	- - R/W-1 R/W-0 PMPIP2 PMPIP1 PMPIP2 PMPIP2 POR '1' = Bit is set Unimplemented: Read as '0' PMPIP Interrupt is priority 1 000 = Interrupt source is disabled Unimplemented: Read as '0' OC8IP OC8IP<2:0>: Output Compare Channel 8 I	- - - R/W-1 R/W-0 R/W-0 U-0 PMPIP2 PMPIP1 PMPIP0 - e bit W = Writable bit U = Unimplem POR '1' = Bit is set '0' = Bit is clear Unimplemented: Read as '0' PMPIP PMPIP I11 = Interrupt is priority 7 (highest priority interrupt) . 001 = Interrupt is priority 1 000 = Interrupt source is disabled Unimplemented: Read as '0'	- - - - R/W-1 R/W-0 R/W-0 U-0 R/W-1 PMPIP2 PMPIP1 PMPIP0 - OC8IP2 e bit W = Writable bit U = Unimplemented bit, read POR '1' = Bit is set '0' = Bit is cleared Unimplemented: Read as '0' PMPIP Port Interrupt Priority bits 111 = Interrupt is priority 7 (highest priority interrupt) .	R/W-1 R/W-0 R/W-0 R/W-1 R/W-0 PMPIP2 PMPIP1 PMPIP0 OC8IP2 OC8IP1 e bit W = Writable bit U = Unimplemented bit, read as '0' POR '1' = Bit is set '0' = Bit is cleared x = Bit is unkn Unimplemented: Read as '0' PMPIP Port Interrupt Priority bits 111 = Interrupt is priority 7 (highest priority interrupt) . .	

REGISTER 7-28: IPC11: INTERRUPT PRIORITY CONTROL REGISTER 11

7.4 Interrupt Setup Procedures

7.4.1 INITIALIZATION

To configure an interrupt source:

- 1. Set the NSTDIS Control bit (INTCON1<15>) if nested interrupts are not desired.
- Select the user-assigned priority level for the interrupt source by writing the control bits in the appropriate IPCx register. The priority level will depend on the specific application and type of interrupt source. If multiple priority levels are not desired, the IPCx register control bits for all enabled interrupt sources may be programmed to the same non-zero value.

Note:	At a device Reset, the IPCx registers are										
	initialized, such that all user interrupt										
	sources are assigned to priority level 4.										

- 3. Clear the interrupt flag status bit associated with the peripheral in the associated IFSx register.
- 4. Enable the interrupt source by setting the interrupt enable control bit associated with the source in the appropriate IECx register.

7.4.2 INTERRUPT SERVICE ROUTINE

The method that is used to declare an ISR and initialize the IVT with the correct vector address will depend on the programming language (i.e., 'C' or assembler) and the language development toolsuite that is used to develop the application. In general, the user must clear the interrupt flag in the appropriate IFSx register for the source of the interrupt that the ISR handles. Otherwise, the ISR will be re-entered immediately after exiting the routine. If the ISR is coded in assembly language, it must be terminated using a RETFIE instruction to unstack the saved PC value, SRL value and old CPU priority level.

7.4.3 TRAP SERVICE ROUTINE

A Trap Service Routine (TSR) is coded like an ISR, except that the appropriate trap status flag in the INTCON1 register must be cleared to avoid re-entry into the TSR.

7.4.4 INTERRUPT DISABLE

All user interrupts can be disabled using the following procedure:

- 1. Push the current SR value onto the software stack using the PUSH instruction.
- 2. Force the CPU to priority level 7 by inclusive ORing the value E0h with SRL.

To enable user interrupts, the POP instruction may be used to restore the previous SR value.

Note that only user interrupts with a priority level of 7 or less can be disabled. Trap sources (level 8-15) cannot be disabled.

The DISI instruction provides a convenient way to disable interrupts of priority levels 1-6 for a fixed period of time. Level 7 interrupt sources are not disabled by the DISI instruction.

15.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, Section 23. "Serial Peripheral Interface (SPI)" (DS39699).

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with Motorola's SPI and SIOP interfaces. All devices of the PIC24FJ256GB110 family include three SPI modules

The module supports operation in two buffer modes. In Standard mode, data is shifted through a single serial buffer. In Enhanced Buffer mode, data is shifted through an 8-level FIFO buffer.

Note: Do not perform read-modify-write operations (such as bit-oriented instructions) on the SPIxBUF register in either Standard or Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported. The SPI serial interface consists of four pins:

- SDIx: Serial Data Input
- SDOx: Serial Data Output
- SCKx: Shift Clock Input or Output
- SSx: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using 2, 3 or 4 pins. In the 3-pin mode, SSx is not used. In the 2-pin mode, both SDOx and SSx are not used.

Block diagrams of the module in Standard and Enhanced modes are shown in Figure 15-1 and Figure 15-2.

Note: In this section, the SPI modules are referred to together as SPIx or separately as SPI1, SPI2 or SPI3. Special Function Registers will follow a similar notation. For example, SPIxCON1 and SPIxCON2 refer to the control registers for any of the 3 SPI modules.

17.1 UART Baud Rate Generator (BRG)

The UART module includes a dedicated 16-bit Baud Rate Generator. The UxBRG register controls the period of a free-running, 16-bit timer. Equation 17-1 shows the formula for computation of the baud rate with BRGH = 0.

EQUATION 17-1: UART BAUD RATE WITH BRGH = $0^{(1,2)}$

Baud Rate = $\frac{FCY}{16 \cdot (UxBRG + 1)}$ UxBRG = $\frac{FCY}{16 \cdot Baud Rate} - 1$

Note 1: FCY denotes the instruction cycle clock

- frequency (Fosc/2).
 - **2:** Based on FCY = FOSC/2, Doze mode and PLL are disabled.

Example 17-1 shows the calculation of the baud rate error for the following conditions:

- Fcy = 4 MHz
- Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is FCY/16 (for UxBRG = 0) and the minimum baud rate possible is FCY/(16 * 65536).

Equation 17-2 shows the formula for computation of the baud rate with BRGH = 1.

EQUATION 17-2: UART BAUD RATE WITH BRGH = $1^{(1,2)}$

		Baud Rate = $\frac{FCY}{4 \cdot (UxBRG + 1)}$
		$UxBRG = \frac{FCY}{4 \cdot Baud Rate} - 1$
Note	1:	Fcy denotes the instruction cycle clock frequency.
	э.	Deced on Fox - Foco/2 Deza made

2: Based on FCY = FOSC/2, Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is FcY/4 (for UxBRG = 0) and the minimum baud rate possible is FcY/(4 * 65536).

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

EXAMPLE 17-1: BAUD RATE ERROR CALCULATION (BRGH = 0)⁽¹⁾

Desired Baud Rate = FCY/(16 (UxBRG + 1))Solving for UxBRG value: UxBRG = ((FCY/Desired Baud Rate)/16) - 1UxBRG = ((400000/9600)/16) - 1UxBRG = 2.5 Calculated Baud Rate= 4000000/(16 (25 + 1)) 9615 = Error (Calculated Baud Rate - Desired Baud Rate) = Desired Baud Rate = (9615 - 9600)/9600= 0.16%**Note 1:** Based on FCY = FOSC/2, Doze mode and PLL are disabled.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
—	_	—		—		—	_					
bit 15							bit 8					
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
DPPULUP	DMPULUP	DPPULDWN ⁽¹⁾	DMPULDWN ⁽¹⁾	VBUSON ⁽¹⁾	OTGEN ⁽¹⁾	VBUSCHG ⁽¹⁾	VBUSDIS ⁽¹⁾					
bit 7							bit (
Legend:												
R = Readabl	le hit	W = Writable bit		U = Unimpler	nented hit re	ad as 'O'						
-n = Value at		'1' = Bit is set		'0' = Bit is cle		x = Bit is unkn	iown					
				0 Dicio die								
bit 15-8	Unimpleme	nted: Read as '0'										
bit 7	-	D+ Pull-Up Enabl										
		line pull-up resist										
		line pull-up resist										
bit 6		DMPULUP: D- Pull-Up Enable bit										
		line pull-up resist line pull-up resist										
bit 5		l: D+ Pull-Down E										
		line pull-down re										
		line pull-down re										
bit 4		I: D- Pull-Down E										
		line pull-down res										
bit 3		line pull-down res BUS Power-on bit										
DIL J	1 = VBUS lin											
		e not powered										
bit 2	OTGEN: OT	G Features Enab	le bit ⁽¹⁾									
		G enabled; all D-										
		G disabled; D+/D N and USBEN bit			ontrolled in ha	ardware by the	settings of the					
bit 1		VBUS Charge Sel										
		e set to charge to										
		e set to charge to										
bit 0	VBUSDIS: V	виs Discharge E	nable bit ⁽¹⁾									
	1 = VBUS lin	e discharged thro										
		e not discharged										

Note 1: These bits are only used in Host mode; do not use in Device mode.

REGISTER 18-5: U1PWRC: USB POWER CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0, HS	U-0	U-0	R/W-0	U-0	U-0	R/W-0, HC	R/W-0
UACTPND	—	—	USLPGRD	—	—	USUSPND	USBPWR
bit 7							bit 0

Legend: HS = Hardware Settable bit		HC = Hardware Clearable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-8	Unimplemented: Read as '0'
bit 7	UACTPND: USB Activity Pending bit
	 1 = Module should not be suspended at the moment (requires USLPGRD bit to be set) 0 = Module may be suspended or powered down
bit 6-5	Unimplemented: Read as '0'
bit 4	USLPGRD: Sleep/Suspend Guard bit
	 1 = Indicate to the USB module that it is about to be suspended or powered down 0 = No suspend
bit 3-2	Unimplemented: Read as '0'
bit 1	USUSPND: USB Suspend Mode Enable bit
	 1 = USB OTG module is in Suspend mode; USB clock is gated and the transceiver is placed in a low-power state
	0 = Normal USB OTG operation
bit 0	USBPWR: USB Operation Enable bit
	1 = USB OTG module is enabled
	$0 = \text{USB OTG module is disabled}^{(1)}$
Nata A.	

Note 1: Do not clear this bit unless the HOSTEN, USBEN and OTGEN bits (U1CON<3,0> and U1OTGCON<2>) are all cleared.

REGISTER 18-16: U1IR: USB INTERRUPT STATUS REGISTER (DEVICE MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/K-0, HS	U-0	R/K-0, HS	R/K-0, HS	R/K-0, HS	R/K-0, HS	R-0	R/K-0, HS
STALLIF	—	RESUMEIF	IDLEIF	TRNIF	SOFIF	UERRIF	URSTIF
bit 7					•		bit 0

Legend:	U = Unimplemented bit, read as '0'					
R = Readable bit	K = Write '1' to clear bit	HS = Hardware Settable bit				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 15-8	Unimplemented: Read as '0'
bit 7	STALLIF: STALL Handshake Interrupt bit
	 1 = A STALL handshake was sent by the peripheral during the handshake phase of the transaction in Device mode
	0 = A STALL handshake has not been sent
bit 6	Unimplemented: Read as '0'
bit 5	RESUMEIF: Resume Interrupt bit
	 1 = A K-state is observed on the D+ or D- pin for 2.5 μs (differential '1' for low speed, differential '0' for full speed) 0 = No K-state observed
bit 4	IDLEIF: Idle Detect Interrupt bit
DIL 4	 1 = Idle condition detected (constant Idle state of 3 ms or more) 0 = No Idle condition detected
bit 3	TRNIF: Token Processing Complete Interrupt bit
	 1 = Processing of current token is complete; read U1STAT register for endpoint information 0 = Processing of current token not complete; clear U1STAT register or load next token from STAT (clearing this bit causes the STAT FIFO to advance)
bit 2	SOFIF: Start-Of-Frame Token Interrupt bit
	1 = A Start-Of-Frame token received by the peripheral or the Start-Of-Frame threshold reached by the host
	0 = No Start-Of-Frame token received or threshold reached
bit 1	UERRIF : USB Error Condition Interrupt bit (read-only)
	 1 = An unmasked error condition has occurred; only error states enabled in the U1EIE register can set this bit
	0 = No unmasked error condition has occurred
bit 0	URSTIF: USB Reset Interrupt bit
	 1 = Valid USB Reset has occurred for at least 2.5 μs; Reset state must be cleared before this bit can be reasserted
	0 = No USB Reset has occurred. Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise oper- ations to write to a single bit position will cause all set bits at the moment of the write to become cleared.
Note:	Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise operations to write to a single bit position will cause all set bits at the moment of the write to become cleared.

NOTES:

R/W-0	U-0	R/W-0	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0	R/W-0	R/W-0
PMPEN	_	PSIDL	ADRMUX1	ADRMUX0	PTBEEN	PTWREN	PTRDEN
bit 15							bit 8
DAVO	DAMA	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	DAM 0(1)	DAMA	DAMO	DAMA
R/W-0	R/W-0	-	-	R/W-0 ⁽¹⁾	R/W-0	R/W-0	R/W-0
CSF1	CSF0	ALP	CS2P	CS1P	BEP	WRSP	RDSP
bit 7							bit (
Legend:							
R = Readabl	e bit	W = Writable	bit	U = Unimplem	ented bit, read	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ired	x = Bit is unkn	iown
bit 15	1 = PMP ena	allel Master Po abled abled, no off-ch		ormed			
bit 14	Unimplemer	nted: Read as '	0'				
bit 13	PSIDL: Stop	in Idle Mode bi	t				
		nue module ope e module opera		evice enters Idle le	e mode		
bit 12-11	ADRMUX<1	:0>: Address/D	ata Multiplexing	Selection bits ⁽	1)		
bit 10	01 = Lower PMA< 00 = Addres PTBEEN: By	8 bits of addre 10:8> ss and data app rte Enable Port	ess are multiple bear on separat	on PMD<7:0> exed on PMD< e pins Bit Master mode	7:0> pins, upp	oer 3 bits are r	nultiplexed o
	1 = PMBE po 0 = PMBE po						
bit 9	1 = PMWR/	/rite Enable Stro PMENB port en PMENB port dis	abled	e bit			
bit 8		ead/Write Strob		bit			
	0 = PMRD/F	MWR port disa	bled				
bit 7-6	CSF1:CSF0:	Chip Select Fu	Inction bits				
		and PMCS2 fu	nip select, PMC	S1 functions as		4	
		and PMCS2 fu	inction as addre	ESS DILS TO ATTU			
bit 5	00 = PMCS1	and PMCS2 fu s Latch Polarity					
bit 5	00 = PMCS1 ALP: Addres 1 = Active-h		/ bit ⁽¹⁾ d <u>PMALH</u>)				
bit 5 bit 4	00 = PMCS1 ALP: Addres 1 = Active-h 0 = Active-lo	s Latch Polarity	/ bit ⁽¹⁾ d PMALH) PMALH)				
	00 = PMCS1 ALP: Addres 1 = Active-h 0 = Active-lc CS2P: Chip 1 = Active-h	s Latch Polarity igh <u>(PMALL</u> and w (PMALL and	/ bit ⁽¹⁾ d PMALH) PMALH) y bit ⁽¹⁾ //CS2)				
	00 = PMCS1 ALP: Addres 1 = Active-h 0 = Active-lc CS2P: Chip S 1 = Active-h 0 = Active-lc	s Latch Polarity igh <u>(PMALL</u> and w (PMALL and Select 2 Polarit igh <u>(PMCS2/P</u> M	r bit ⁽¹⁾ DMALH) PMALH) y bit ⁽¹⁾ MCS2) CS2)				

REGISTER 19-1: PMCON: PARALLEL PORT CONTROL REGISTER

Note 1: These bits have no effect when their corresponding pins are used as address lines.

26.5 JTAG Interface

PIC24FJ256GB110 family devices implement a JTAG interface, which supports boundary scan device testing.

26.6 In-Circuit Serial Programming

PIC24FJ256GB110 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock (PGECx) and data (PGEDx) and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

26.7 In-Circuit Debugger

When MPLAB[®] ICD 2 is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the PGECx (Emulation/Debug Clock) and PGEDx (Emulation/Debug Data) pins.

To use the in-circuit debugger function of the device, the design must implement ICSP connections to \overline{MCLR} , VDD, VSS and the PGECx/PGEDx pin pair designated by the ICS Configuration bits. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.

DC CHARAC	TERISTICS		Standard Op Operating ter	Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Parameter No.	Typical ⁽¹⁾	Max	Units	Conditions					
Idle Current (
DC40	220	310	μA	-40°C					
DC40a	220	310	μA	+25°C	2.0∨ ⁽³⁾				
DC40b	220	310	μA	+85°C		1 MIPS			
DC40d	300	390	μA	-40°C					
DC40e	300	390	μA	+25°C	3.3∨ ⁽⁴⁾				
DC40f	300	420	μA	+85°C					
DC43	0.85	1.1	mA	-40°C					
DC43a	0.85	1.1	mA	+25°C	2.0∨ ⁽³⁾	4 MIPS			
DC43b	0.87	1.2	mA	+85°C					
DC43d	1.1	1.4	mA	-40°C		4 101125			
DC43e	1.1	1.4	mA	+25°C	3.3∨ ⁽⁴⁾				
DC43f	1.1	1.4	mA	+85°C					
DC47	4.4	5.6	mA	-40°C					
DC47a	4.4	5.6	mA	+25°C	2.5∨ ⁽³⁾				
DC47b	4.4	5.6	mA	+85°C		- 16 MIPS			
DC47c	4.4	5.6	mA	-40°C					
DC47d	4.4	5.6	mA	+25°C	3.3∨ ⁽⁴⁾				
DC47e	4.4	5.6	mA	+85°C					
DC50	1.1	1.4	mA	-40°C					
DC50a	1.1	1.4	mA	+25°C	2.0∨ ⁽³⁾				
DC50b	1.1	1.4	mA	+85°C					
DC50d	1.4	1.8	mA	-40°C		FRC (4 MIPS)			
DC50e	1.4	1.8	mA	+25°C	3.3∨ ⁽⁴⁾				
DC50f	1.4	1.8	mA	+85°C					
DC51	4.3	13	μA	-40°C					
DC51a	4.5	13	μA	+25°C	2.0V ⁽³⁾				
DC51b	10	32	μA	+85°C					
DC51d	44	77	μA	-40°C		LPRC (31 kHz)			
DC51e	44	77	μA	+25°C	3.3∨ ⁽⁴⁾				
DC51f	70	132	μA	+85°C	1				

TABLE 29-5: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base IIDLE current is measured with the core off, OSCI driven with external square wave from rail to rail. All I/O pins are configured as inputs and pulled to VDD. MCLR = VDD; WDT and FSCM are disabled. No peripheral modules are operating and all of the Peripheral Module Disable (PMD) bits are set.

3: On-chip voltage regulator disabled (ENVREG tied to Vss).

4: On-chip voltage regulator enabled (ENVREG tied to VDD). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated)						
			Operating temp	erature	-40°C ≤ 1	Ā ≤ +85°	C for Industrial		
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions		
	VIL	Input Low Voltage ⁽⁴⁾							
DI10		I/O Pins with ST Buffer	Vss	_	0.2 VDD	V			
DI11		I/O Pins with TTL Buffer	Vss	_	0.15 VDD	V			
DI15		MCLR	Vss	_	0.2 VDD	V			
DI16		OSC1 (XT mode)	Vss	_	0.2 VDD	V			
DI17		OSC1 (HS mode)	Vss	_	0.2 VDD	V			
DI18		I/O Pins with I ² C™ Buffer:	Vss	_	0.3 VDD	V			
DI19		I/O Pins with SMBus Buffer:	Vss	_	0.8	V	SMBus enabled		
	VIH	Input High Voltage ⁽⁴⁾							
DI20		I/O Pins with ST Buffer: with Analog Functions, Digital Only	0.8 Vdd 0.8 Vdd	_	VDD 5.5	V V			
DI21		I/O Pins with TTL Buffer: with Analog Functions, Digital Only	0.25 Vdd + 0.8 0.25 Vdd + 0.8	_	VDD 5.5	V V			
DI25		MCLR	0.8 VDD	_	Vdd	V			
DI26		OSC1 (XT mode)	0.7 Vdd	_	Vdd	V			
DI27		OSC1 (HS mode)	0.7 Vdd	_	Vdd	V			
DI28		I/O Pins with I ² C Buffer: with Analog Functions, Digital Only	0.7 Vdd 0.7 Vdd	_	VDD 5.5	V V			
DI29		I/O Pins with SMBus Buffer: with Analog Functions, Digital Only	2.1 2.1		VDD 5.5	V V	$2.5V \le VPIN \le VDD$		
DI30	ICNPU	CNxx Pull-up Current	50	250	400	μA	VDD = 3.3V, VPIN = VSS		
DI30A	ICNPD	CNxx Pull-Down Current	—	80	_	μA	VDD = 3.3V, VPIN = VDD		
	lı∟	Input Leakage Current ^(2,3)							
DI50		I/O Ports	—	—	<u>+</u> 1	μA	Vss ≤ VPIN ≤ VDD, Pin at high-impedance		
DI51		Analog Input Pins	—	—	<u>+</u> 1	μA	$Vss \le VPIN \le VDD,$ Pin at high-impedance		
DI52		USB Differential Pins (D+, D-)	—	—	<u>+</u> 1	μΑ	$V \text{USB} \geq V \text{DD}$		
DI55		MCLR	_	—	<u>+</u> 1	μA	$Vss \leq V \text{PIN} \leq V \text{DD}$		
DI56		OSC1	—	_	<u>+</u> 1	μA	$\label{eq:VSS} \begin{split} &V{\sf SS} \leq V{\sf PIN} \leq V{\sf DD}, \\ &X{\sf T} \text{ and } H{\sf S} \text{ modes} \end{split}$		

TABLE 29-7: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

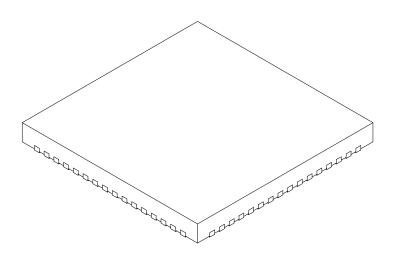
2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

4: Refer to Table 1-4 for I/O pins buffer types.

64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			S
Dimensi	MIN	NOM	MAX	
Number of Pins	N		64	
Pitch	е		0.50 BSC	_
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	ntact Thickness A3 0.20 RI			
Overall Width	E	9.00 BSC		
Exposed Pad Width	E2	7.05 7.15 7.50		
Overall Length	D		9.00 BSC	
Exposed Pad Length	D2	7.05	7.15	7.50
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-149B Sheet 2 of 2



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